

REMARKS

Applicant respectfully requests that the foregoing amendments be made prior to examination of the present application.

In the specification, the title has been amended.

Paragraphs have been amended on pages 1 and 10 to correct typographical errors in two headings.

Claims 1-19 are currently being amended, in order to remove numerical labels from those claims, so as to place those claims in better form for U.S. patent practice.

This amendment amends claims in this application. A detailed listing of all claims that are, or were, in the application, irrespective of whether the claim(s) remain under examination in the application, is presented, with an appropriate defined status identifier.

Respectfully submitted,

Date: December 22, 2005

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ABSTRACT

~~[Object] A cooling device for a thin electronic equipment having a larger heat radiation area and preventing leakage of refrigerant.~~

~~[Means for Solving Problems]~~ A cooling device includes a cooling panel wherein a passage ~~[(21)]~~ is formed by bonding together a bottom heat radiation plate having a groove formed therein and a top heat radiation plate, and a circulation pump ~~[(3)]~~ circulating refrigerant within the passage ~~[(21)]~~. The top heat radiation plate is provided with an outlet port through which the refrigerant flows out from the passage ~~[(21)]~~ to the circulation pump ~~[(3)]~~ and an inlet port through which the refrigerant flows in from the circulation pump ~~[(3)]~~ to the passage ~~[(21)]~~. The circulation pump ~~[(3)]~~ is fixed onto the top heat radiation plate of the cooling panel ~~[(2)]~~ so that the suction port and discharge port are aligned with the outlet port and inlet port, respectively.